PCN # 1801D1

unchanged.

DATE: April 15, 2019

EXPECTED PCN SHIP DATE: April 15, 2019



**Quality Assurance** 160 Rio Robles San Jose, CA 95134

www.maximintegrated.com

<b>X</b> PRODUCT CHANGE NOTICE	
MAXIM INTEGRATED HEREBY ISSUES NOTIFICATION OF CHANGE THAT MAY AFFECT THE FOLLOWING CATEGORIES:	
X DESIGN ☐ WAFER FAB   ☐ ASSEMBI	Y TEST ELEC/MECH SPECS
AFFECTED PRODUCT:	
Ordering P/N: (See PN listing XLS in PCN ZIP file)	
CHANGE FROM: -	CHANGE TO: -
Die design change for MAX9259/MAX9301 (GMSL1 devices)	
DieID/Die Revision (HS40Y/VBZD)	DieID/Die revision HS40Y/CUI0
	New die has an added High Pass Filter/HPF (resistor and
	capacitor) in the serial clock signal path between SSPLL buffer
	output and P2S (parallel-to-serial) buffer input
JUSTIFICATION: -	
To improve the production test yield performance of these devices, a simple metal mask change is required by adding a High Pas	
Filter/HPF (described above). This change is required to ensure supply chain continuity by eliminating the inconsisten	

PROCESS CHANGE NOTICE

TRACEABILITY: Maxim Integrated maintains full traceability by device marking, packaging labels and shipment documents.

Maxim Integrated's Change Notification System is designed to keep our customer base apprised of major product, manufacturing, or facility improvements.

or

manufacturing yield for max frequency performance. The datasheet electrical table specifications and overall content remain

Nasser Ali Chronche

Nasser AliChaouche / PCN Coordinator

For further information, please contact either of the people listed below.

The form, fit and function of these devices are identical before/after the change.

**Contact your local Maxim Integrated Company Representative** 

Nasser AliChaouche, PCN Coordinator 408-601-5660 / pcn.coordinator@maximintegrated.com

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